

4V Drive Nch MOSFET

RSJ550N10

Structure

Silicon N-channel MOSFET

Features

- 1) Low on-resistance.
- 2) High Power Package.
- 3) 4V drive.

Application

Switching

Packaging specifications

	Package	Taping	
Type	Code	TL	
	Basic ordering unit (pieces)	1000	
RSJ550N1	0		

● Absolute maximum ratings (Ta = 25°C)

Param	Symbol	Symbol Limits		
Drain-source voltage		V_{DSS}	100	V
Gate-source voltage		V_{GSS}	<u>+20</u>	V
Drain current	Continuous	I _D *3	±55	Α
	Pulsed	I _{DP} *1	±110	Α
Source current	Continuous	I _S *3	55	Α
(Body Diode)	Pulsed	I _{SP} *1	110	Α
Power dissipation		P _D *2	100	W
Channel temperature		Tch	150	°C
Range of storage temperature		Tstg -55 to +150		°C

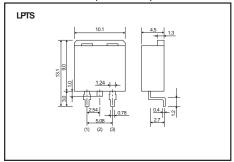
^{*1} $P_W \le 10 \mu s$, Duty cycle $\le 1\%$

• Thermal resistance

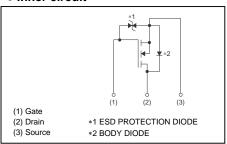
Parameter	Symbol	Limits	Unit
Channel to Case	Rth (ch-c)*	1.25	°C/W

^{*} T_C=25°C

• Dimensions (Unit : mm)



• Inner circuit



^{*2} T_C=25°C

^{*3} Please use within the range of SOA.

● Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	I_{GSS}	1	-	±10	μA	$V_{GS}=\pm20V, V_{DS}=0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	100	-	-	٧	I _D =1mA, V _{GS} =0V
Zero gate voltage drain current	I _{DSS}	1	-	1	μA	V _{DS} =100V, V _{GS} =0V
Gate threshold voltage	V _{GS (th)}	1	-	2.5	٧	V_{DS} =10V, I_{D} =1mA
Static drain-source on-state	R _{DS (on)} *	1	12	16.8	mΩ	I _D =27.5A, V _{GS} =10V
resistance	DS (on)	1	13.5	18.9		I _D =27.5A, V _{GS} =4V
Forward transfer admittance	ΙΥ _{fs} Γ΄	30	-	-	S	V _{DS} =10V, I _D =27.5A
Input capacitance	C _{iss}	1	6150	-	pF	V _{DS} =25V
Output capacitance	C _{oss}	1	460	-	pF	V _{GS} =0V
Reverse transfer capacitance	C _{rss}	1	320	-	pF	f=1MHz
Turn-on delay time	t _{d(on)} *	1	32	-	ns	V _{DD} ≒50V, I _D =27.5A
Rise time	t _r *	1	105	-	ns	V _{GS} =10V
Turn-off delay time	t _{d(off)} *	ı	375	-	ns	R _L =1.82Ω
Fall time	t _f *	ı	360	-	ns	$R_G=10\Omega$
Total gate charge	Q _g *	-	143	-	nC	V _{DD} ≒50V, I _D =27.5A
Gate-source charge	Q _{gs} *	-	16	-	nC	V _{GS} =10V
Gate-drain charge	Q _{gd} *	-	34	-	nC	

^{*}Pulsed

●Body diode characteristics (Source-Drain)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward Voltage	V _{SD} *	-	-	1.5	V	I _s =55A, V _{GS} =0V

^{*}Pulsed

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●Electrical characteristic curves (Ta=25°C)

50 T_a=25°C V_{GS}=10.0V pulsed V_{GS}=4.5V 40 4.0V Drain Current : I_D [A] V_{GS}=3.0V 30 V_{GS}=2.8V 20 V_{GS}=2.5V 10 0 0 0.2 0.4 0.6 0.8 Drain-Source Voltage : V_{DS} [V]

Fig.1 Typical Output Characteristics (I)

Fig.3 Static Drain-Source On-State Resistance vs. Drain Current

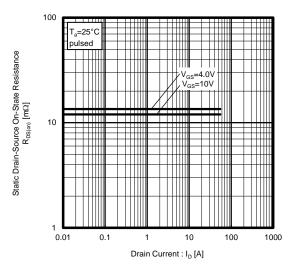


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

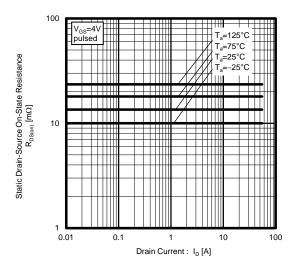


Fig.2 Typical Output Characteristics (II)

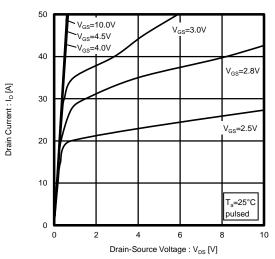


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current

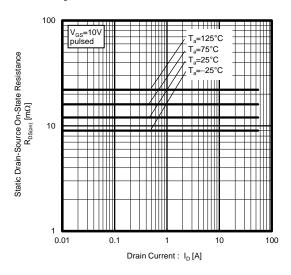


Fig.6 Typical Transfer Characteristics

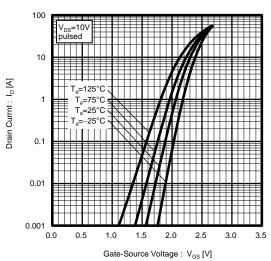


Fig.7 Source Current vs. Source-Drain Voltage

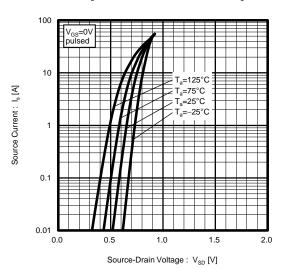


Fig.9 Switching Characteristics

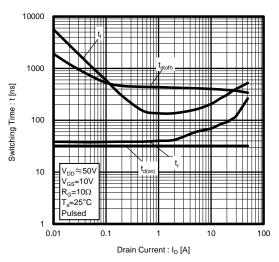


Fig.11 Typical Capacitance vs. Drain-Source Voltage

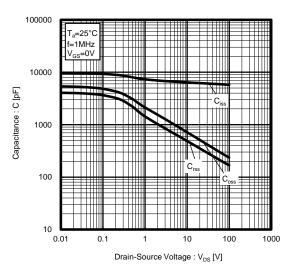


Fig.8 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

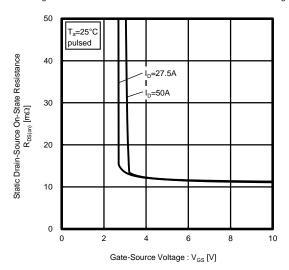


Fig.10 Dynamic Input Characteristics

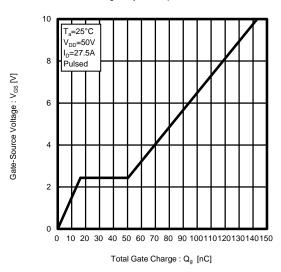
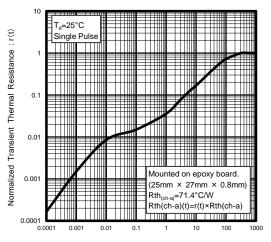
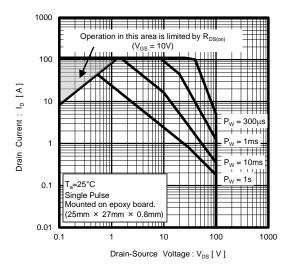


Fig.12 Normalized Transient Thermal Resistance v.s. Pulse Width



Pulse width : Pw (s)

Fig.13 Maximum Safe Operating Area



Measurement circuits

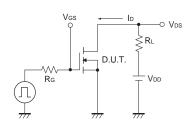


Fig.1-1 Switching Time Measurement Circuit

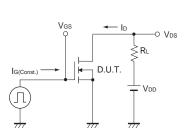


Fig.2-1 Gate Charge Measurement Circuit

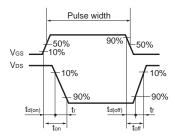


Fig.1-2 Switching Waveforms

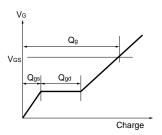


Fig.2-2 Gate Charge Waveform

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